



## FAST CMOS 18-BIT REGISTERED TRANSCEIVER

**IDT74FCT16500AT/CT**

### FEATURES:

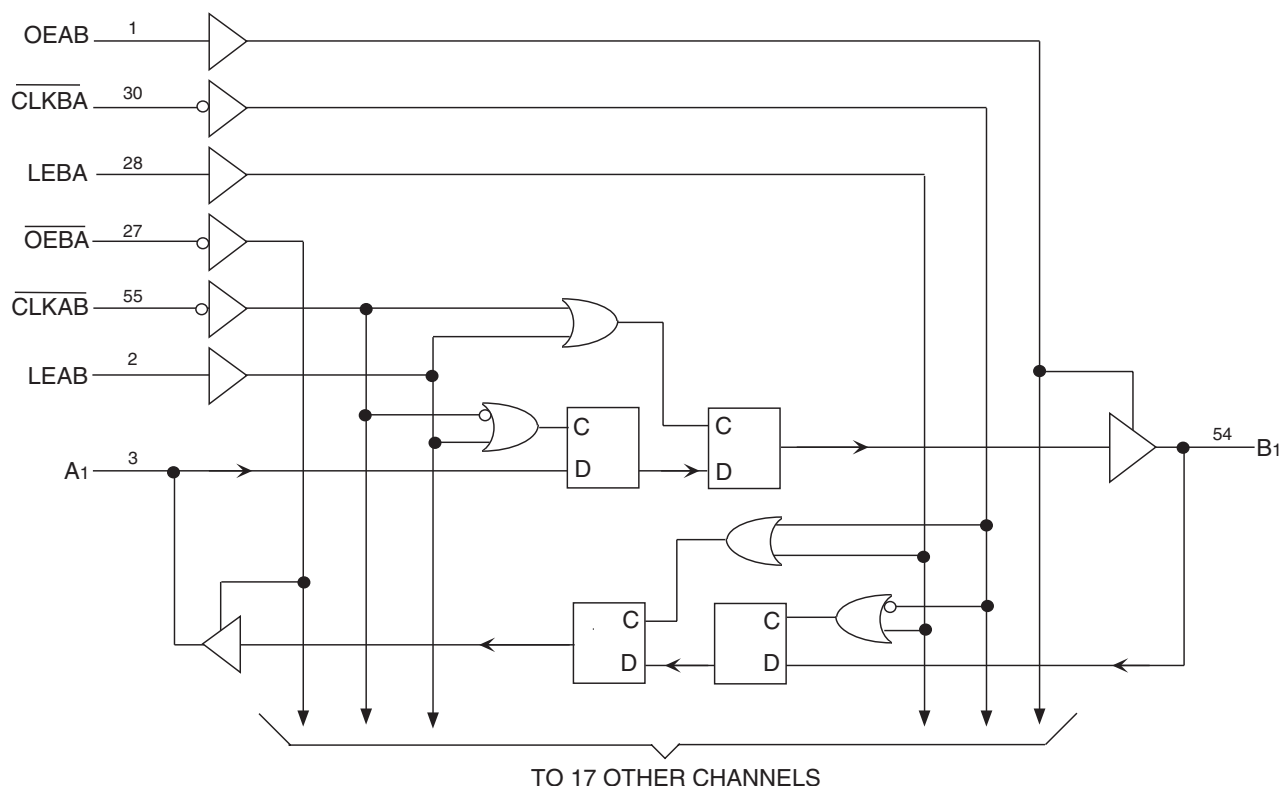
- 0.5 MICRON CMOS Technology
- High-speed, low-power CMOS replacement for ABT functions
- Typical  $t_{sk(o)}$  (Output Skew) < 250ps
- Low input and output leakage  $\leq 1\mu A$  (max.)
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- $V_{cc} = 5V \pm 10\%$
- High drive outputs ( $-32mA$   $I_{OH}$ ,  $64mA$   $I_{OL}$ )
- Power off disable outputs permit "live insertion"
- Typical  $V_{OLP}$  (Output Ground Bounce) < 1.0V at  $V_{cc} = 5V$ ,  $T_A = 25^\circ C$
- Available in SSOP package

### DESCRIPTION:

The FCT16500T 18-bit registered transceivers are built using advanced dual metal CMOS technology. These high-speed, low-power 18-bit registered bus transceivers combine D-type latches and D-type flip-flops to allow data flow in transparent, latched and clocked modes. Data flow in each direction is controlled by output-enable ( $OEAB$  and  $\overline{OEBA}$ ), latch enable ( $LEAB$  and  $LEBA$ ) and clock ( $\overline{CLKAB}$  and  $\overline{CLKBA}$ ) inputs. For A-to-B data flow, the device operates in transparent mode when  $LEAB$  is high. When  $LEAB$  is low, the A data is latched if  $\overline{CLKAB}$  is held at a high or low logic level. If  $LEAB$  is low, the A bus data is stored in the latch/flip-flop on the high-to-low transition of  $\overline{CLKAB}$ .  $OEAB$  performs the output enable function on the B port. Data flow from B port to A port is similar but uses  $\overline{OEBA}$ ,  $LEBA$  and  $\overline{CLKBA}$ . Flow-through organization of signal pins simplifies layout. All inputs are designed with hysteresis for improved noise margin.

The FCT16500T are ideally suited for driving high-capacitance loads and low-impedance backplanes. The output buffers are designed with power off disable capability to allow "live insertion" of boards when used as backplane drivers.

### FUNCTIONAL BLOCK DIAGRAM

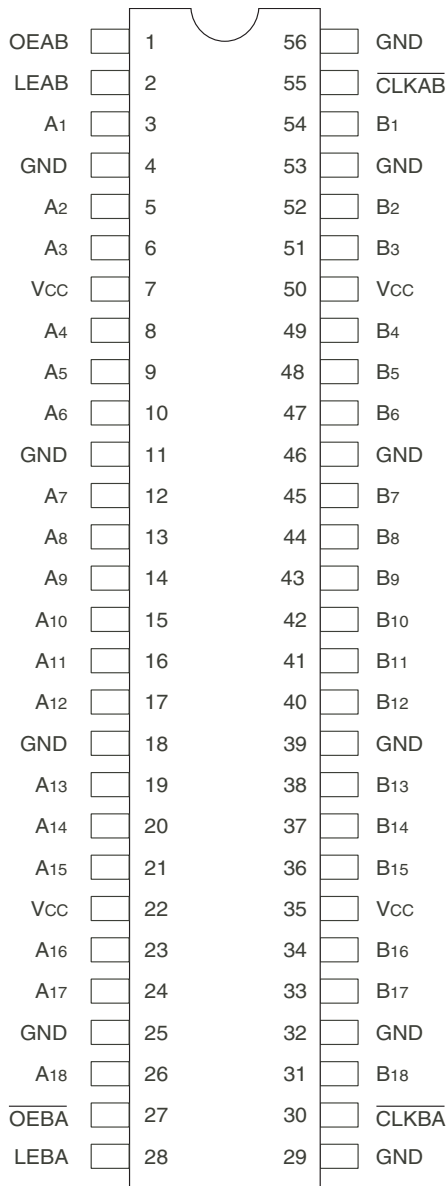


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**INDUSTRIAL TEMPERATURE RANGE**

**SEPTEMBER 2009**

## PIN CONFIGURATION



SSOP  
TOP VIEW

## PIN DESCRIPTION

| Pin Names                 | Description                                  |
|---------------------------|----------------------------------------------|
| OEAB                      | A-to-B Output Enable Input                   |
| $\overline{\text{OEBA}}$  | B-to-A Output Enable Input (Active LOW)      |
| LEAB                      | A-to-B Latch Enable Input                    |
| LEBA                      | B-to-A Latch Enable Input                    |
| $\overline{\text{CLKAB}}$ | A-to-B Clock Input (Active LOW)              |
| $\overline{\text{CLKBA}}$ | B-to-A Clock Input (Active LOW)              |
| Ax                        | A-to-B Data Inputs or B-to-A 3-State Outputs |
| Bx                        | B-to-A Data Inputs or A-to-B 3-State Outputs |

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

| Symbol                  | Description                          | Max                         | Unit |
|-------------------------|--------------------------------------|-----------------------------|------|
| $V_{\text{TERM}}^{(2)}$ | Terminal Voltage with Respect to GND | -0.5 to 7                   | V    |
| $V_{\text{TERM}}^{(3)}$ | Terminal Voltage with Respect to GND | -0.5 to $V_{\text{CC}}+0.5$ | V    |
| TSTG                    | Storage Temperature                  | -65 to +150                 | °C   |
| IOUT                    | DC Output Current                    | -60 to +120                 | mA   |

### NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- All device terminals except FCT162XXX Output and I/O terminals.
- Output and I/O terminals for FCT162XXX.

## CAPACITANCE ( $T_A = +25^\circ\text{C}$ , $f = 1.0\text{MHz}$ )

| Symbol           | Parameter <sup>(1)</sup> | Conditions                   | Typ. | Max. | Unit |
|------------------|--------------------------|------------------------------|------|------|------|
| $C_{\text{IN}}$  | Input Capacitance        | $V_{\text{IN}} = 0\text{V}$  | 3.5  | 6    | pF   |
| $C_{\text{OUT}}$ | Output Capacitance       | $V_{\text{OUT}} = 0\text{V}$ | 3.5  | 8    | pF   |

### NOTE:

- This parameter is measured at characterization but not tested.

## FUNCTION TABLE<sup>(1, 4)</sup>

| Inputs |      |                           |    | Outputs   |
|--------|------|---------------------------|----|-----------|
| OEAB   | LEAB | $\overline{\text{CLKAB}}$ | Ax | Bx        |
| L      | X    | X                         | X  | Z         |
| H      | H    | X                         | L  | L         |
| H      | H    | X                         | H  | H         |
| H      | L    | ↓                         | L  | L         |
| H      | L    | ↓                         | H  | H         |
| H      | L    | H                         | X  | $B^{(2)}$ |
| H      | L    | L                         | X  | $B^{(3)}$ |

### NOTES:

- A-to-B data flow is shown. B-to-A data flow is similar but uses  $\overline{\text{OEBA}}$ , LEBA, and CLKBA.
- Output level before the indicated steady-state input conditions were established.
- Output level before the indicated steady-state input conditions were established, provided that CLKAB was LOW before LEAB went LOW.
- H = HIGH Voltage Level  
L = LOW Voltage Level  
X = Don't Care  
Z = High-impedance  
↓ = HIGH-to-LOW Transition

## DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Industrial:  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{CC} = 5.0\text{V} \pm 10\%$

| Symbol                              | Parameter                                                             | Test Conditions <sup>(1)</sup>                             |                     | Min. | Typ. <sup>(2)</sup> | Max.    | Unit          |
|-------------------------------------|-----------------------------------------------------------------------|------------------------------------------------------------|---------------------|------|---------------------|---------|---------------|
| $V_{IH}$                            | Input HIGH Level                                                      | Guaranteed Logic HIGH Level                                |                     | 2    | —                   | —       | V             |
| $V_{IL}$                            | Input LOW Level                                                       | Guaranteed Logic LOW Level                                 |                     | —    | —                   | 0.8     | V             |
| $I_{IH}$                            | Input HIGH Current (Input pins) <sup>(5)</sup>                        | $V_{CC} = \text{Max.}$                                     | $V_I = V_{CC}$      | —    | —                   | $\pm 1$ | $\mu\text{A}$ |
|                                     | Input HIGH Current (I/O pins) <sup>(5)</sup>                          |                                                            |                     | —    | —                   | $\pm 1$ |               |
| $I_{IL}$                            | Input LOW Current (Input pins) <sup>(5)</sup>                         |                                                            | $V_I = \text{GND}$  | —    | —                   | $\pm 1$ |               |
|                                     | Input LOW Current (I/O pins) <sup>(5)</sup>                           |                                                            |                     | —    | —                   | $\pm 1$ |               |
| $I_{OZH}$                           | High Impedance Output Current<br>(3-State Output pins) <sup>(5)</sup> | $V_{CC} = \text{Max.}$                                     | $V_O = 2.7\text{V}$ | —    | —                   | $\pm 1$ | $\mu\text{A}$ |
| $I_{OZL}$                           |                                                                       |                                                            | $V_O = 0.5\text{V}$ | —    | —                   | $\pm 1$ |               |
| $V_{IK}$                            | Clamp Diode Voltage                                                   | $V_{CC} = \text{Min.}, I_{IN} = -18\text{mA}$              |                     | —    | -0.7                | -1.2    | V             |
| $I_{OS}$                            | Short Circuit Current                                                 | $V_{CC} = \text{Max.}, V_O = \text{GND}^{(3)}$             |                     | -80  | -140                | -250    | mA            |
| $V_H$                               | Input Hysteresis                                                      | —                                                          |                     | —    | 100                 | —       | mV            |
| $I_{CCL}$<br>$I_{CCH}$<br>$I_{CCZ}$ | Quiescent Power Supply Current                                        | $V_{CC} = \text{Max.}$<br>$V_{IN} = \text{GND or } V_{CC}$ |                     | —    | 5                   | 500     | $\mu\text{A}$ |

## OUTPUT DRIVE CHARACTERISTICS

| Symbol    | Parameter                                     | Test Conditions <sup>(1)</sup>                                 |                               | Min. | Typ. <sup>(2)</sup> | Max.    | Unit          |
|-----------|-----------------------------------------------|----------------------------------------------------------------|-------------------------------|------|---------------------|---------|---------------|
| $I_O$     | Output Drive Current                          | $V_{CC} = \text{Max.}, V_O = 2.5\text{V}^{(3)}$                |                               | -50  | —                   | -180    | mA            |
| $V_{OH}$  | Output HIGH Voltage                           | $V_{CC} = \text{Min.}$<br>$V_{IN} = V_{IH} \text{ or } V_{IL}$ | $I_{OH} = -3\text{mA}$        | 2.5  | 3.5                 | —       | V             |
|           |                                               |                                                                | $I_{OH} = -15\text{mA}$       | 2.4  | 3.5                 | —       |               |
|           |                                               |                                                                | $I_{OH} = -32\text{mA}^{(4)}$ | 2    | 3                   | —       |               |
| $V_{OL}$  | Output LOW Voltage                            | $V_{CC} = \text{Min.}$<br>$V_{IN} = V_{IH} \text{ or } V_{IL}$ | $I_{OL} = 64\text{mA}$        | —    | 0.2                 | 0.55    | V             |
| $I_{OFF}$ | Input/Output Power Off Leakage <sup>(5)</sup> | $V_{CC} = 0\text{V}, V_{IN} \text{ or } V_O \leq 4.5\text{V}$  |                               | —    | —                   | $\pm 1$ | $\mu\text{A}$ |

### NOTES:

- For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at  $V_{CC} = 5.0\text{V}$ ,  $+25^{\circ}\text{C}$  ambient.
- Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- Duration of the condition can not exceed one second.
- This test limit for this parameter is  $\pm 5\mu\text{A}$  at  $T_A = -55^{\circ}\text{C}$ .

## POWER SUPPLY CHARACTERISTICS

| Symbol          | Parameter                                      | Test Conditions <sup>(1)</sup>                                                                                                                                                                                                   |                                            | Min. | Typ. <sup>(2)</sup> | Max.                | Unit             |
|-----------------|------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------|------|---------------------|---------------------|------------------|
| $\Delta I_{CC}$ | Quiescent Power Supply Current TTL Inputs HIGH | $V_{CC} = \text{Max.}$<br>$V_{IN} = 3.4V^{(3)}$                                                                                                                                                                                  |                                            | —    | 0.5                 | 1.5                 | mA               |
| $I_{CCD}$       | Dynamic Power Supply Current <sup>(4)</sup>    | $V_{CC} = \text{Max.},$<br>Outputs Open<br>$OEAB = \overline{OEBA} = V_{CC} \text{ or GND}$<br>One Input Toggling<br>50% Duty Cycle                                                                                              | $V_{IN} = V_{CC}$<br>$V_{IN} = \text{GND}$ | —    | 75                  | 120                 | $\mu A /$<br>MHz |
| $I_C$           | Total Power Supply Current <sup>(6)</sup>      | $V_{CC} = \text{Max.},$<br>Outputs Open<br>$f_{CP} = 10\text{MHz } (\overline{CLKAB})$<br>50% Duty Cycle<br>$OEAB = \overline{OEBA} = V_{CC}$<br>LEAB = GND<br>One Bit Toggling<br>$f_i = 5\text{MHz}$<br>50% Duty Cycle         | $V_{IN} = V_{CC}$<br>$V_{IN} = \text{GND}$ | —    | 0.8                 | 1.7                 | mA               |
|                 |                                                | LEAB = GND<br>One Bit Toggling<br>$f_i = 5\text{MHz}$<br>50% Duty Cycle                                                                                                                                                          | $V_{IN} = 3.4V$<br>$V_{IN} = \text{GND}$   | —    | 1.3                 | 3.2                 |                  |
|                 |                                                | $V_{CC} = \text{Max.},$<br>Outputs Open<br>$f_{CP} = 10\text{MHz } (\overline{CLKAB})$<br>50% Duty Cycle<br>$OEAB = \overline{OEBA} = V_{CC}$<br>LEAB = GND<br>Eighteen Bits Toggling<br>$f_i = 2.5\text{MHz}$<br>50% Duty Cycle | $V_{IN} = V_{CC}$<br>$V_{IN} = \text{GND}$ | —    | 3.8                 | 6.5 <sup>(5)</sup>  |                  |
|                 |                                                | Eighteen Bits Toggling<br>$f_i = 2.5\text{MHz}$<br>50% Duty Cycle                                                                                                                                                                | $V_{IN} = 3.4V$<br>$V_{IN} = \text{GND}$   | —    | 8.5                 | 20.8 <sup>(5)</sup> |                  |

### NOTES:

- For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at  $V_{CC} = 5.0V$ ,  $+25^\circ C$  ambient.
- Per TTL driven input ( $V_{IN} = 3.4V$ ). All other inputs at  $V_{CC}$  or GND.
- This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- Values for these conditions are examples of the  $I_{CC}$  formula. These limits are guaranteed but not tested.
- $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$   
 $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_{CP} N_{CP} / 2 + f_i N_i)$   
 $I_{CC} = \text{Quiescent Current } (I_{CCL}, I_{CCH} \text{ and } I_{CCZ})$   
 $\Delta I_{CC} = \text{Power Supply Current for a TTL High Input } (V_{IN} = 3.4V)$   
 $D_H = \text{Duty Cycle for TTL Inputs High}$   
 $N_T = \text{Number of TTL Inputs at } D_H$   
 $I_{CCD} = \text{Dynamic Current Caused by an Input Transition Pair (HLH or LHL)}$   
 $f_{CP} = \text{Clock Frequency for Register Devices (Zero for Non-Register Devices)}$   
 $N_{CP} = \text{Number of Clock Inputs at } f_{CP}$   
 $f_i = \text{Input Frequency}$   
 $N_i = \text{Number of Inputs at } f_i$

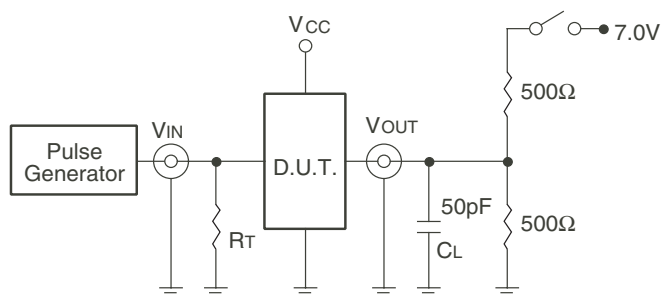
## SWITCHING CHARACTERISTICS OVER OPERATING RANGE

| Symbol             | Parameter                                              |            | Condition <sup>(1)</sup> | FCT16500AT          |      | FCT16500CT          |      | Unit |
|--------------------|--------------------------------------------------------|------------|--------------------------|---------------------|------|---------------------|------|------|
|                    |                                                        |            |                          | Min. <sup>(2)</sup> | Max. | Min. <sup>(2)</sup> | Max. |      |
| f <sub>MAX</sub>   | CLKAB or CLKBA frequency <sup>(3)</sup>                |            | CL = 50pF<br>RL = 500Ω   | —                   | 150  | —                   | 150  | MHz  |
| t <sub>PLH</sub>   | Propagation Delay                                      |            |                          | 1.5                 | 5.1  | 1.5                 | 3.8  | ns   |
| t <sub>PHL</sub>   | Ax to Bx or Bx to Ax                                   |            |                          |                     |      |                     |      |      |
| t <sub>PLH</sub>   | Propagation Delay                                      |            |                          | 1.5                 | 5.6  | 1.5                 | 4.2  | ns   |
| t <sub>PHL</sub>   | LEBA to Ax, LEAB to Bx                                 |            |                          |                     |      |                     |      |      |
| t <sub>PLH</sub>   | Propagation Delay                                      |            |                          | 1.5                 | 5.6  | 1.5                 | 4.4  | ns   |
| t <sub>PHL</sub>   | CLKBA to Ax, CLKAB to Bx                               |            |                          |                     |      |                     |      |      |
| t <sub>PZH</sub>   | Output Enable Time                                     |            |                          | 1.5                 | 6    | 1.5                 | 4.8  | ns   |
| t <sub>PZL</sub>   | OEBA to Ax, OEAB to Bx                                 |            |                          |                     |      |                     |      |      |
| t <sub>PHZ</sub>   | Output Disable Time                                    |            |                          | 1.5                 | 5.6  | 1.5                 | 4.4  | ns   |
| t <sub>PLZ</sub>   | OEBA to Ax, OEAB to Bx                                 |            |                          |                     |      |                     |      |      |
| t <sub>SU</sub>    | Set-up Time, HIGH or LOW<br>Ax to CLKAB, Bx to CLKBA   |            |                          | 3                   | —    | 2.4                 | —    | ns   |
| t <sub>H</sub>     | Hold Time, HIGH or LOW<br>Ax to CLKAB, Bx to CLKBA     |            |                          | 0                   | —    | 0                   | —    | ns   |
| t <sub>SU</sub>    | Set-up Time HIGH or LOW<br>Ax to LEAB, Bx to LEBA      | Clock HIGH |                          | 3                   | —    | 2                   | —    | ns   |
|                    |                                                        | Clock LOW  | 1.5                      | —                   | 1.5  | —                   |      |      |
| t <sub>H</sub>     | Hold Time, HIGH or LOW<br>Ax to LEAB, Bx to LEBA       |            | 1.5                      | —                   | 0.5  | —                   | ns   |      |
| t <sub>w</sub>     | LEAB or LEBA Pulse Width HIGH <sup>(3)</sup>           |            | 3                        | —                   | 3    | —                   | ns   |      |
| t <sub>w</sub>     | CLKAB or CLKBA Pulse Width, HIGH or LOW <sup>(3)</sup> |            | 3                        | —                   | 3    | —                   | ns   |      |
| t <sub>SK(O)</sub> | Output Skew <sup>(4)</sup>                             |            | —                        | 0.5                 | —    | 0.5                 | ns   |      |

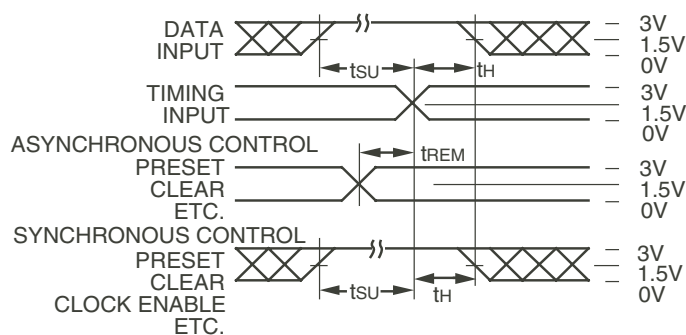
### NOTES:

- See test circuits and waveforms.
- Minimum limits are guaranteed but not tested on Propagation Delays.
- This parameter is guaranteed but not tested.
- Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

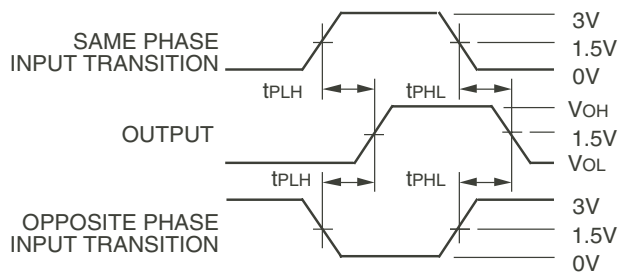
## TEST CIRCUITS AND WAVEFORMS



Test Circuits for All Outputs



Set-up, Hold, and Release Times



Propagation Delay

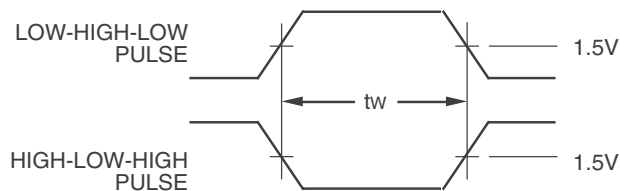
## SWITCH POSITION

| Test                                    | Switch |
|-----------------------------------------|--------|
| Open Drain<br>Disable Low<br>Enable Low | Closed |
| All Other Tests                         | Open   |

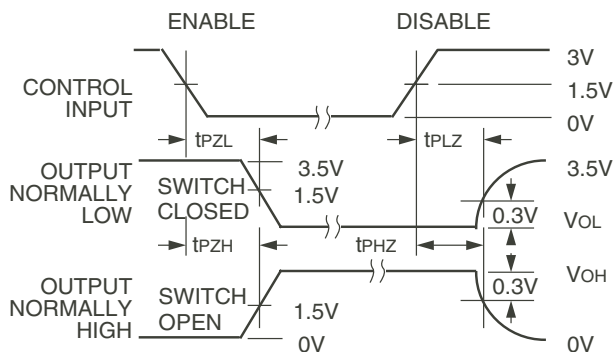
### DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.



Pulse Width

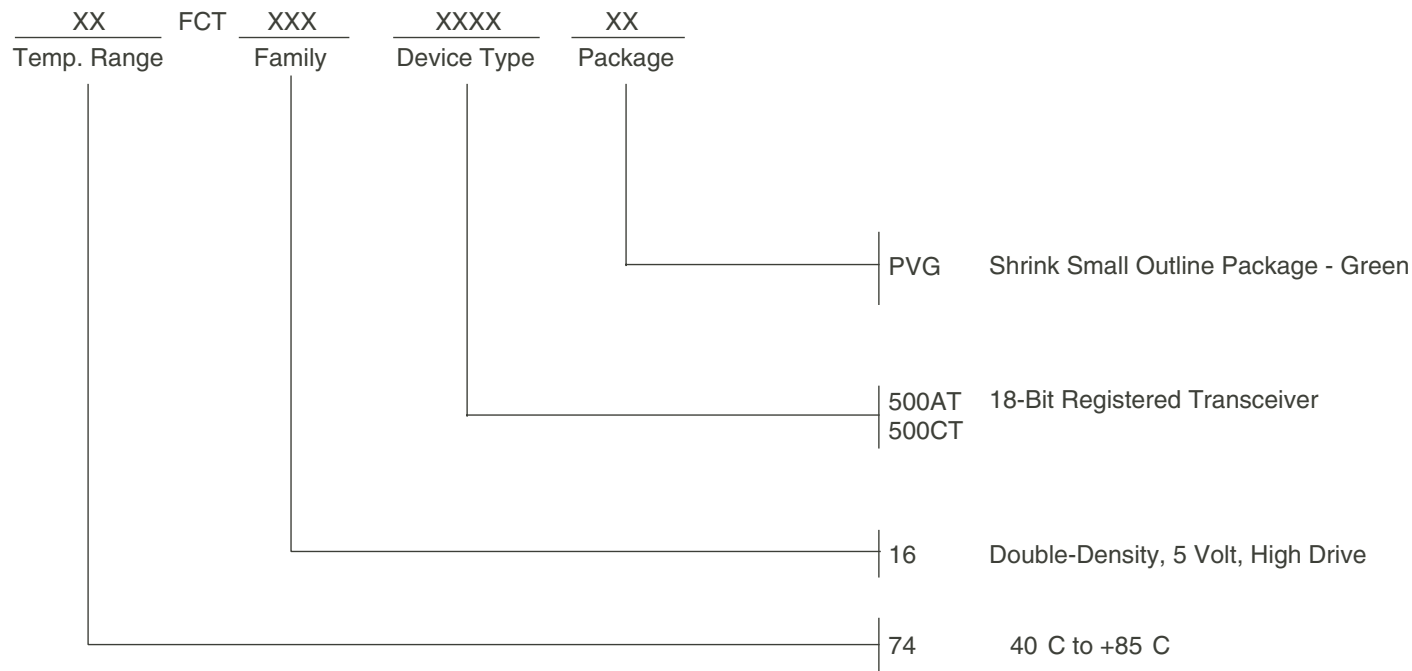


Enable and Disable Times

### NOTES:

- Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
- Pulse Generator for All Pulses: Rate  $\leq 1.0\text{MHz}$ ;  $t_r \leq 2.5\text{ns}$ ;  $t_r \leq 2.5\text{ns}$ .

## ORDERING INFORMATION



## Datasheet Document History

09/28/09 Pg. 7 Updated the ordering information by removing the "IDT" notation and non RoHS part.



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